

February 2025 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. [The January Report SEAJ's Web site update](#) is scheduled on **24th April** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **February 2025 Billings of ¥412,065 million**

Tokyo Japan, **March 25th, 2025** JAPAN-based manufacturers of semiconductor equipment posted **¥412,065 million** in billings in **February 2025**(three-month average basis) published today by SEAJ.

The billings figure is **1.1% percent down** the final **January 2025** level of **¥416,790 million** and **29.8 percent up** the **2024 February** billings level of **¥317,418 million**.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
September 2024	369,598	5.3%	23.4%
October 2024	385,676	4.4%	33.4%
November 2024	405,788	5.2%	35.2%
December 2024	443,364	9.3%	44.7%
January 2025(final)	416,790	-6.0%	32.4%
February 2025(prelim)	412,065	-1.1%	29.8%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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